

# Single P-channel MOSFET

ELM17407FA-S

## ■ General description

ELM17407FA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and operation with gate voltages as low as 1.8V.

## ■ Features

- $V_{ds} = -20V$
- $I_d = -1.2A$  ( $V_{gs} = -4.5V$ )
- $R_{ds(on)} < 135m\Omega$  ( $V_{gs} = -4.5V$ )
- $R_{ds(on)} < 170m\Omega$  ( $V_{gs} = -2.5V$ )
- $R_{ds(on)} < 220m\Omega$  ( $V_{gs} = -1.8V$ )

## ■ Maximum absolute ratings

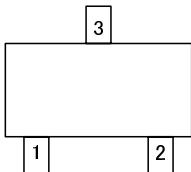
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	-20	V	
Gate-source voltage	$V_{gs}$	$\pm 8$	V	
Continuous drain current Ta=25°C	$I_d$	-1.2	A	1
Ta=70°C		-1.0		
Pulsed drain current	$I_{dm}$	-10	A	2
Power dissipation Ta=25°C	$P_d$	0.35	W	1
Ta=70°C		0.22		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

## ■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	300	360	°C/W	1
Maximum junction-to-ambient	Steady-state		350	425	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	280	320	°C/W	3

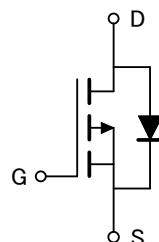
## ■ Pin configuration

SC-70 (TOP VIEW)



Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

## ■ Circuit



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### ■ Electrical characteristics

T<sub>a</sub>=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V	-20			V
Zero gate voltage drain current	Idss	Vds=-16V			-1	μ A
		Vgs=0V	T <sub>j</sub> =55°C		-5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±8V			±100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μA	-0.30	-0.55	-1.00	V
On state drain current	Id(on)	Vgs=-4.5V, Vds=-5V	-10			A
Static drain-source on-resistance	Rds(on)	Vgs=-4.5V		111	135	m Ω
		Id=-1.2A	T <sub>j</sub> =125°C	141	175	
		Vgs=-2.5V, Id=-1A		137	170	m Ω
		Vgs=-1.8V, Id=-1A		169	220	m Ω
Forward transconductance	Gfs	Vds=-5V, Id=-3A	4	7		S
Diode forward voltage	Vsd	Is=-1A, Vgs=0V		-0.78	-1.00	V
Max. body-diode continuous current	Is				-0.6	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	Ciss	Vgs=0V, Vds=-10V, f=1MHz		540		pF
Output capacitance	Coss			72		pF
Reverse transfer capacitance	Crss			49		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		12		Ω
<b>SWITCHING PARAMETERS</b>						
Total gate charge	Qg	Vgs=-4.5V, Vds=-10V Id=-1A		6.20		nC
Gate-source charge	Qgs			0.54		nC
Gate-drain charge	Qgd			1.44		nC
Turn-on delay time	td(on)	Vgs=-4.5V, Vds=-10V R <sub>l</sub> =15 Ω, R <sub>gen</sub> =3 Ω		12.0		ns
Turn-on rise time	tr			10.7		ns
Turn-off delay time	td(off)			74.0		ns
Turn-off fall time	tf			28.7		ns
Body diode reverse recovery time	trr	I <sub>f</sub> =-1A, dI/dt=100A/μs		24.5		ns
Body diode reverse recovery charge	Qrr	I <sub>f</sub> =-1A, dI/dt=100A/μs		17.4		nC

### NOTE :

1. The value of R<sub>θja</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with T<sub>a</sub>=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R<sub>θja</sub> is the sum of the thermal impedance from junction to lead R<sub>θjl</sub> and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>a</sub>=25°C. The SOA curve provides a single pulse rating.



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## ■ Typical electrical and thermal characteristics

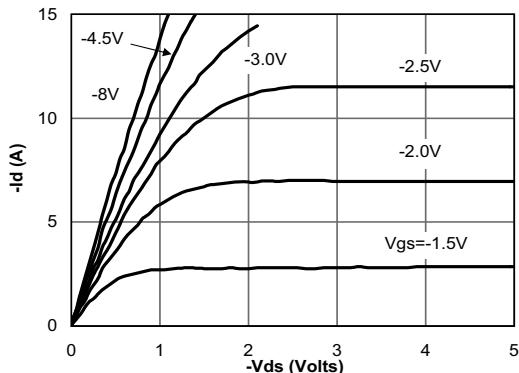


Fig 1: On-Region Characteristics

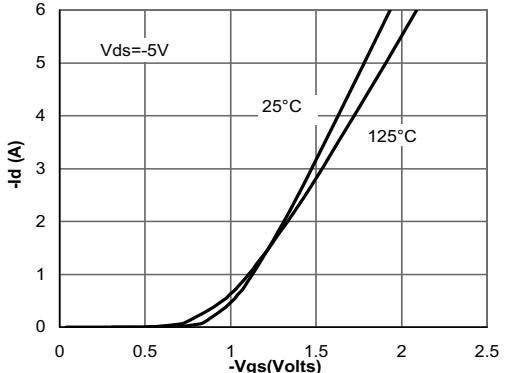


Figure 2: Transfer Characteristics

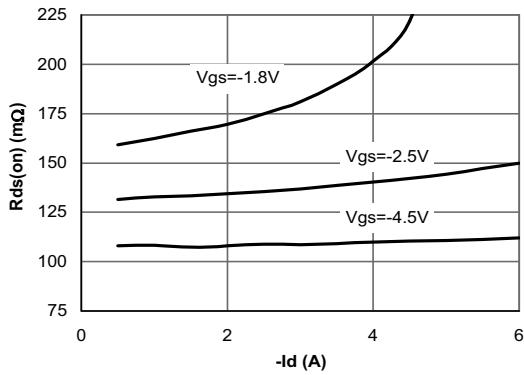


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

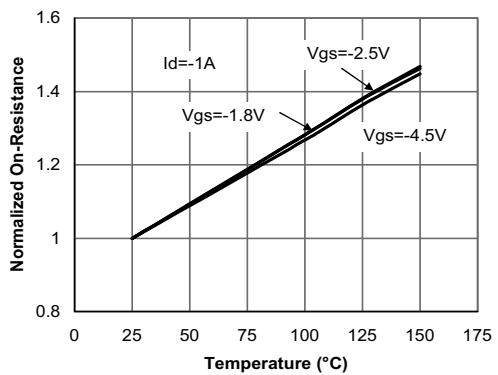


Figure 4: On-Resistance vs. Junction Temperature

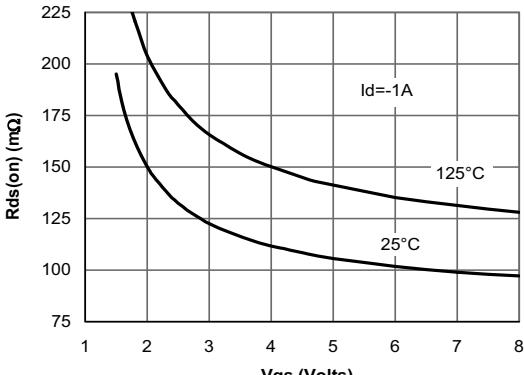


Figure 5: On-Resistance vs. Gate-Source Voltage

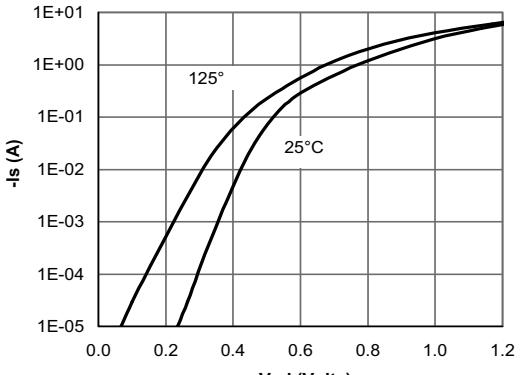


Figure 6: Body-Diode Characteristics

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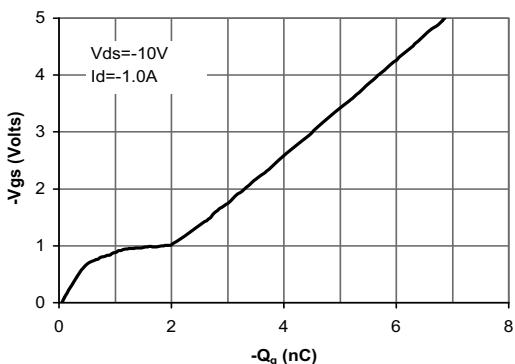


Figure 7: Gate-Charge Characteristics

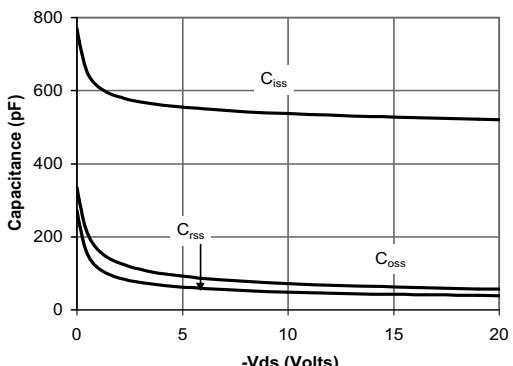


Figure 8: Capacitance Characteristics

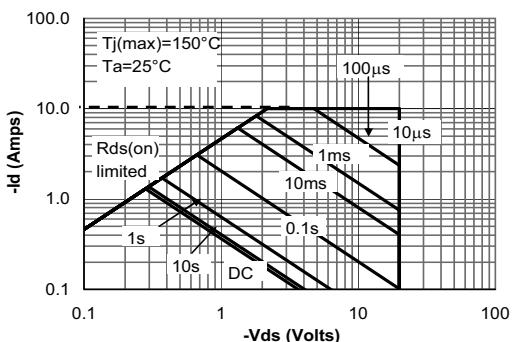


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

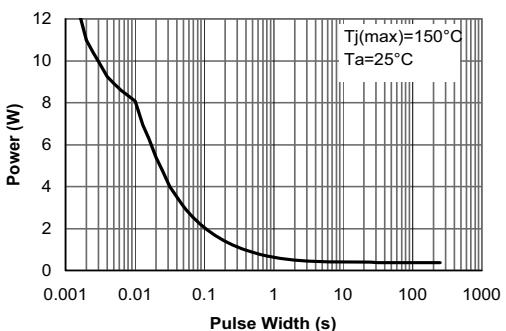


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

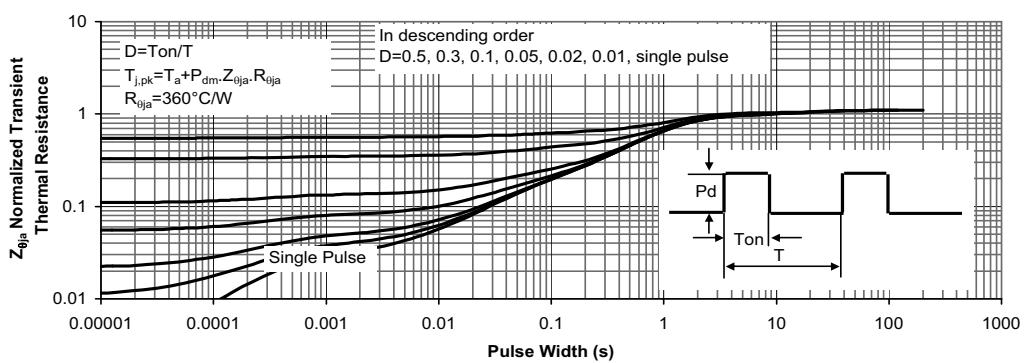


Figure 11: Normalized Maximum Transient Thermal Impedance